T-33-05

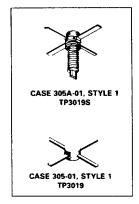
The RF Line **UHF Power Transistors**

The TP3019 and TP3019S are designed for 24 V common emitter base station amplifiers. Operating in the 820-960 MHz bandwidth, they have been specifically designed for use in analog and digital (GSM) systems. The studiess package version offers a good possibility for surface mounting.

• Specified 24 Volts, 960 MHz Characteristics Output Power = 2.0 Watts Minimum Gain = 9.0 dB Class AB $I_Q = 20 \text{ mA}$

TP3019 TP3019S

2.0 W-960 MHz **UHF POWER** TRANSISTORS **NPN SILICON**



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	VCER	40	Vdc
Collector Base Voltage	V _{CBO}	50	Vdc
Emitter-Base Voltage	VEBO	40	Vdc
Collector-Current — Continuous	¹c	10	Adc
Total Device Dissipation in T _C 25 C Derate above 25 C	PD	12.5 0.15	Watts W^C
Storage Temperature Range	T _{stg}	65 to + 150	°C
Operating Junction Temperature	Tj	200	Ċ

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit	ĺ
Thermal Resistance, Junction to Case (1) at 70 C Case	R _{#JC}	14	C/W	ĺ

ELECTRICAL CHARACTERISTICS (T_C 25 C unless otherwise noted)

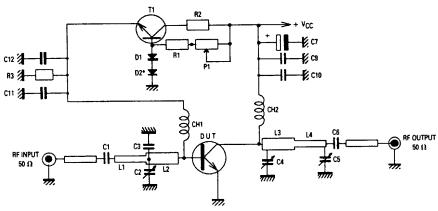
Characteristic	Symbol	Min	Тур	Max	Unit
FF CHARACTERISTICS					
Collector-Emitter Breakdown Voltage (IC = 5.0 mA, IB 0)	V(BR)CER	28	_	-	Vdc
Emitter-Base Breakdown Voltage	V(BR)EBO	3 5	_	-	Vdc
Collector-Base Breakdown Voltage (IE 5 0 mAdc)	V(BR)CBO	50	_	-	Vdc
Collector-Emitter Leakage (VCE 20 V)	ICES	_		2.0	mA
OTE 1 Thermal resistance is determined under specified RF ope	rating condition			•	(contin

MOTOROLA RF DEVICE DATA

2-1186

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Mex	Unit
ON CHARACTERISTICS					
DC Current Gain (IC = 1 0 Adc, VCE = 5.0 Vdc)	hŁE	15	_	150	
DYNAMIC CHARACTERISTICS					
Output Capacitance (VCB = 25 V, IE = 0, f = 1 0 MHz)	C ^{OP}	-	_	4.0	pF
UNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain (VCC = 24 V, Pout = 2.0 W, ICQ = 20 mA) (f = 960 MHz)	Gp	9.0	_	_	dB
Load Mismatch at all Phase Angles (V _{CC} = 24 V, P _{Out} = 2.0 W, I _{CQ} = 20 mA) No degradation in Output Power	ψ	20:1		_	VSWR
Collector Efficiency (VCC = 24 V, Pout = 2.0 W, f = 960 MHz)	ηc	50	55	_	%



*Contact with RF Transistor

C2, C4, C5 — Trimmer Capacitor 0.5–4.0 pF C1, C6, C10, C11 — Capacitor Chip 0805 330 pF 5% C9, C12 — Capacitor Chip 0805 15 nF 5% C3 — Capacitor Chip 0805 3.9 pF 5% C7 — Capacitor Chip 0805 6.0, 8.0 μ F 35 V R1 — Resistor 1.0 k Ω 5% L1 — Microstrip Line 50 Ω L = 12 mm L2 — Microstrip Line 25 Ω L = 6 mm

R3 — Chip Resistor 75 Ω 0805 5% P1 — Trimmer 5.0 ktl T1 — Transistor BD135 or Similar CH1 — Microstrip Line 80 Ω L = 23 mm CH2 — 3 Turns Wire 8/10 lD 4 mm D1, D2 — Diode 1N4148 L3 — Microstrip Line 25 Ω L = 6 mm L4 — Microstrip Line 50 Ω L = 28 mm Board Material — 1 50°, Teflon Glass, Cu Clad 2 Sides, 35 μ m Thick

R2 -- Resistor 100 12 2.0 W

Figure 1. 960 MHz Test Circuit

MOTOROLA RF DEVICE DATA

2-1187

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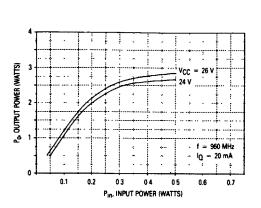
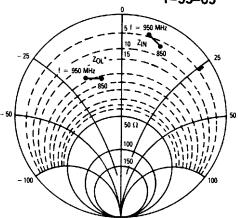


Figure 2. Output Power versus Input Power



Pou	t = 2 M ACE	= 24 V
f	Z _{IN}	ZOL*
MHz	OHMS	OHMS
850	58 + 198	21 3 - ₁ 10
900	54 + 19	21 - ₁ 11
OCA :	4070	20 .44

Z_{QL}* = Conjugate of the optimum load impedance into which the device operates at a given output power, voltage, and frequency

Figure 3. Series Equivalent Input/Output Impedances

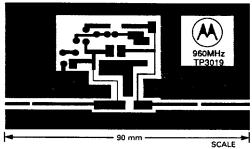


Figure 4. Test Circuit — Photomaster

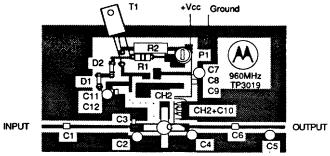


Figure 5. Test Circuit — Component Locations

MOTOROLA RF DEVICE DATA 2-1188

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Advance Information The RF Line **UHF Power Transistor**

The TP3020A is designed for use in the 900 MHz mobile radio band. Its high gain and ability to operate Class A makes it an ideal choice as a driver operating Class A, Class B or Class C.

- 960 MHz

- 2.2 W P_{out}
 26 V V_{CC}
 High Gain 9 dB, Class A

TP3020Á

2.2 W -- 960 MHz UHF POWER TRANSISTOR **NPN SILICON**



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Emitter-Base Voltage	VEBO	3.5	Vdc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	8.75 0.05	Watts W/°C
Operating Junction Temperature	TJ	200	℃
Storage Temperature Range	T _{stg}	-65 to +200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (T _C = 70°C)	R ₆ JC	20	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Түр	Мах	Unit
OFF CHARACTERISTICS					
Emitter-Base Breakdown Voltage (IE = 0.5 mA, IC = 0)	V(BR)EBO	3.5	_	_	Vdc
Collector-Emitter Breakdown Voltage (I _C = 10 mA, R _{BE} = 75 Ω)	V(BR)CER	40	_	_	Vdc
Collector Cutoff Current (VCB = 24 V, IE = 0)	ICBO			0.5	mAdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 100 mA, V _{CE} = 5 V)	hfE	15	_	120	_
DYNAMIC CHARACTERISTICS					
Output Capacitance (VCB = 28 V, IE = 0, f = 1 MHz)	Cop	_	_	5	pF
FUNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain (VCE = 26 V, Pout = 2.2 W, f = 960 MHz, IQ = 200 mA)	GPE	9.1	_	_	d₿

This document contains information on a new product. Specifications and information herein are subject to change without notice.

MOTOROLA RF DEVICE DATA

2-1189

2